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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	20MHz
Connectivity	-
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	5
Program Memory Size	1.75KB (1K x 14)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	64 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	8-TSSOP, 8-MSOP (0.118", 3.00mm Width)
Supplier Device Package	8-MSOP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic12hv609t-i-ms

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

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Міскоснір PIC12F609/615/617/12HV609/615

8-Pin Flash-Based, 8-Bit CMOS Microcontrollers

High-Performance RISC CPU:

- Only 35 Instructions to Learn:
 - All single-cycle instructions except branches
- Operating Speed:
 - DC 20 MHz oscillator/clock input
 - DC 200 ns instruction cycle
- Interrupt Capability
- 8-Level Deep Hardware Stack
- Direct, Indirect and Relative Addressing modes

Special Microcontroller Features:

- Precision Internal Oscillator:
 - Factory calibrated to ±1%, typical
 - Software selectable frequency: 4 MHz or 8 MHz
- Power-Saving Sleep mode
- Voltage Range:
- PIC12F609/615/617: 2.0V to 5.5V
- PIC12HV609/615: 2.0V to user defined maximum (see note)
- Industrial and Extended Temperature Range
- Power-on Reset (POR)
- Power-up Timer (PWRT) and Oscillator Start-up Timer (OST)
- Brown-out Reset (BOR)
- Watchdog Timer (WDT) with independent Oscillator for Reliable Operation
- Multiplexed Master Clear with Pull-up/Input Pin
- Programmable Code Protection
- High Endurance Flash:
 - 100,000 write Flash endurance
 - Flash retention: > 40 years
- Self Read/ Write Program Memory (PIC12F617 only)

Low-Power Features:

- Standby Current:
 - 50 nA @ 2.0V, typical
- Operating Current:
 - 11 μA @ 32 kHz, 2.0V, typical
 - 260 μA @ 4 MHz, 2.0V, typical
- Watchdog Timer Current:
 - 1 μA @ 2.0V, typical
 - Note: Voltage across the shunt regulator should not exceed 5V.

Peripheral Features:

- Shunt Voltage Regulator (PIC12HV609/615 only):
 - 5 volt regulation
 - 4 mA to 50 mA shunt range
- 5 I/O Pins and 1 Input Only
- High Current Source/Sink for Direct LED Drive
 - Interrupt-on-pin change or pins
 - Individually programmable weak pull-ups
- Analog Comparator module with:
 - One analog comparator
 - Programmable on-chip voltage reference (CVREF) module (% of VDD)
 - Comparator inputs and output externally accessible
 - Built-In Hysteresis (software selectable)
- Timer0: 8-Bit Timer/Counter with 8-Bit Programmable Prescaler
- Enhanced Timer1:
 - 16-bit timer/counter with prescaler
 - External Timer1 Gate (count enable)
 - Option to use OSC1 and OSC2 in LP mode as Timer1 oscillator if INTOSC mode selected
 - Option to use system clock as Timer1
- In-Circuit Serial Programming[™] (ICSP[™]) via Two Pins

PIC12F615/617/HV615 ONLY:

- Enhanced Capture, Compare, PWM module:
 - 16-bit Capture, max. resolution 12.5 ns
 - Compare, max. resolution 200 ns
 - 10-bit PWM with 1 or 2 output channels, 1 output channel programmable "dead time," max. frequency 20 kHz, auto-shutdown
- A/D Converter:
 - 10-bit resolution and 4 channels, samples internal voltage references
- Timer2: 8-Bit Timer/Counter with 8-Bit Period Register, Prescaler and Postscaler

PIC12F609/615/617/12HV609/615

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An errata sheet, describing minor operational differences from the data sheet and recommended workarounds, may exist for current devices. As device/documentation issues become known to us, we will publish an errata sheet. The errata will specify the revision of silicon and revision of document to which it applies.

To determine if an errata sheet exists for a particular device, please check with one of the following:

- Microchip's Worldwide Web site; http://www.microchip.com
- · Your local Microchip sales office (see last page)

When contacting a sales office, please specify which device, revision of silicon and data sheet (include literature number) you are using.

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PIC12F609/615/617/12HV609/615

Addr	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Page		
Bank 0													
00h	INDF	Addressing	Addressing this location uses contents of FSR to address data memory (not a physical register)										
01h	TMR0	Timer0 Mod	imer0 Module's Register xxxx xxxx 53, 115										
02h	PCL	Program Co	ounter's (PC)	Least Signifi	cant Byte					0000 0000	25, 115		
03h	STATUS	IRP ⁽¹⁾	RP1 ⁽¹⁾	RP0	TO	PD	Z	DC	С	0001 1xxx	18, 115		
04h	FSR	Indirect Dat	ndirect Data Memory Address Pointer xxxx xxxx 25, 115										
05h	GPIO	_	_	GP5	GP4	GP3	GP2	GP1	GP0	x0 x000	43, 115		
06h	_	Unimpleme	nimplemented — —										
07h	_	Unimpleme	nted							_	_		
08h	_	Unimpleme	nimplemented — —										
09h	_	Unimpleme	nimplemented — —										
0Ah	PCLATH	_	— — — Write Buffer for upper 5 bits of Program Counter0 0000 25, 115										
0Bh	INTCON	GIE	PEIE	T0IE	INTE	GPIE	T0IF	INTF	GPIF	0000 0000	20, 115		
0Ch	PIR1	—	_	_	_	CMIF	-	_	TMR1IF	00 22	:, 115		
0Dh	_	Unimplemented									—		
0Eh	TMR1L	Holding Register for the Least Significant Byte of the 16-bit TMR1 Register									57, 115		
0Fh	TMR1H	Holding Reg	Holding Register for the Most Significant Byte of the 16-bit TMR1 Register xxxx>								57, 115		
10h	T1CON	T1GINV	TMR1GE	T1CKPS1	T1CKPS0	T1OSCEN	T1SYNC	TMR1CS	TMR10N	0000 0000	62, 115		
11h	_	Unimpleme	nted							_	_		
12h	_	Unimpleme	nted							_	_		
13h	_	Unimpleme	nted							_	_		
14h	_	Unimpleme	nted							_	_		
15h	_	Unimpleme	nted							_	_		
16h	—	Unimpleme	nted							-	_		
17h	_	Unimpleme	nted							_	_		
18h	_	Unimpleme	nted							_	_		
19h	VRCON	CMVREN	—	VRR	FVREN	VR3	VR2	VR1	VR0	0-00 0000	76, 116		
1Ah	CMCON0	CMON	COUT	CMOE	CMPOL	_	CMR	_	CMCH	0000 -0-0	72, 116		
1Bh	_					_		—		_			
1Ch	CMCON1	_	—	_	T1ACS	CMHYS	_	T1GSS	CMSYNC	0 0-10 7	3, 116		
1Dh	—	Unimpleme	nted							_	_		
1Eh	_	Unimpleme	Unimplemented							_	_		
1Fh		Unimplemented							_	_			

TABLE 2-1: PIC12F609/HV609 SPECIAL FUNCTION REGISTERS SUMMARY BANK 0

IRP and RP1 bits are reserved, always maintain these bits clear. 1:

2: Read only register.

Addr	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Page		
Bank 0													
00h	INDF	Addressing	ddressing this location uses contents of FSR to address data memory (not a physical register) xxxx xxxx 25, 116										
01h	TMR0	Timer0 Mod	imer0 Module's Register xxxx x53, 116										
02h	PCL	Program Co	rogram Counter's (PC) Least Significant Byte 0000 0000 25, 11										
03h	STATUS	IRP ⁽¹⁾	RP1 ⁽¹⁾	RP0	TO	PD	Z	DC	С	0001 1xxx	8, 116		
04h	FSR	Indirect Data	a Memory Ad	dress Pointe	r					XXXX XXXX 2	5, 116		
05h	GPIO	_	_	GP5	GP4	GP3	GP2	GP1	GP0	x0 x000 4	8, 116		
06h	_	Unimplemer	nimplemented — —										
07h	_	Unimplemen	nted							_	_		
08h	_	Unimplemen	nted							_	_		
09h	_	Unimplemen	nted							_	_		
0Ah	PCLATH	_	_	_	Write	Buffer for u	oper 5 bits of	Program Co	unter	0 0000 2	5, 116		
0Bh	INTCON	GIE	PEIE	T0IE	INTE	GPIE	T0IF	INTF	GPIF	0000 0000	20, 116		
0Ch	PIR1	_	ADIF	CCP1IF	_	CMIF	—	TMR2IF	TMR1IF	-00-0-00 2	2, 116		
0Dh	_	Unimplemented — —											
0Eh	TMR1L	Holding Register for the Least Significant Byte of the 16-bit TMR1 Register xxxx xxxx 57, 116											
0Fh	TMR1H	Holding Register for the Most Significant Byte of the 16-bit TMR1 Register								XXXX XXXX 5	7, 116		
10h	T1CON	T1GINV	TMR1GE	T1CKPS1	T1CKPS0	T1OSCEN	T1SYNC	TMR1CS	TMR1ON	0000 0000	62, 116		
11h	TMR2 ⁽³⁾	Timer2 Mod	ule Register							0000 0000	65, 116		
12h	T2CON ⁽³⁾	_	TOUTPS3	TOUTPS2	TOUTPS1	TOUTPS0	TMR2ON	T2CKPS1	T2CKPS0	-000 0000	6, 116		
13h	CCPR1L ⁽³⁾	Capture/Cor	mpare/PWM	Register 1 Lo	ow Byte					XXXX XXXX	90, 116		
14h	CCPR1H ⁽³⁾	Capture/Cor	mpare/PWM	Register 1 H	igh Byte					XXXX XXXX	90, 116		
15h	CCP1CON ⁽³⁾	P1M	_	DC1B1	DC1B0	CCP1M3	CCP1M2	CCP1M1	CCP1M0	0-00 0000	9, 116		
16h	PWM1CON ⁽³⁾	PRSEN	PDC6	PDC5	PDC4	PDC3	PDC2	PDC1	PDC0	0000 0000	105, 116		
17h	ECCPAS ⁽³⁾	ECCPASE	ECCPAS2	ECCPAS1	ECCPAS0	PSSAC1	PSSAC0	PSSBD1	PSSBD0	0000 0000	102, 116		
18h	_	Unimplemented									—		
19h	VRCON	CMVREN	_	VRR	FVREN	VR3	VR2	VR1	VR0	0-00 0000	6, 116		
1Ah	CMCON0	CMON	COUT	CMOE	CMPOL		CMR		CMCH	0000 -0-0 7	2, 116		
1Bh	_					_		_		—	_		
1Ch	CMCON1	_	-	_	T1ACS	CMHYS	_	T1GSS	CMSYNC	0 0-10 73	, 116		
1Dh	_	Unimplemen	nted							_	_		
1Eh	ADRESH ^(2, 3)	Most Significant 8 bits of the left shifted A/D result or 2 bits of right shifted result xxxx xxxx 85, 116											
1Fh	ADCON0 ⁽³⁾	ADFM	VCFG	—	CHS2	CHS1	CHS0	GO/DONE	ADON	00-0 0000	34, 116		

TABLE 2-2: PIC12F615/617/HV615 SPECIAL FUNCTION REGISTERS SUMMARY BANK 0

Legend: -= Unimplemented locations read as '0', u = unchanged, x = unknown, q = value depends on condition, shaded = unimplemented

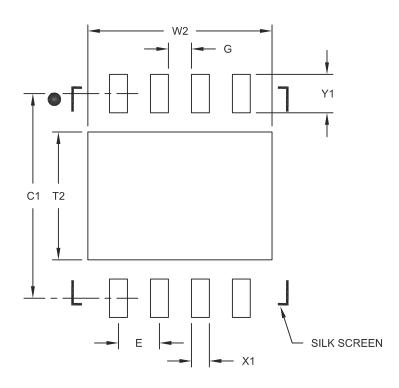
Note 1: IRP and RP1 bits are reserved, always maintain these bits clear.

2: Read only register.

3: PIC12F615/617/HV615 only.

8-Lead Plastic Dual Flat, No Lead Package (MD) – 4x4x0.9 mm Body [DFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

	MILLIMETERS				
Dimensior	MIN	NOM	MAX		
Contact Pitch	0.80 BSC				
Optional Center Pad Width	W2			3.60	
Optional Center Pad Length	T2			2.50	
Contact Pad Spacing	C1		4.00		
Contact Pad Width (X8)	X1			0.35	
Contact Pad Length (X8)	Y1			0.75	
Distance Between Pads	G	0.45			

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2131B